

High Temperature Operation (125°C)

This data sheet addendum is to be used in conjunction with the existing AT25SF041 datasheet specifications. The Adesto AT25SF041 4Mbit Serial Flash devices will operate @ 125°C with the following datasheet caveats. All other parameters will meet the existing datasheet specifications.

The ordering code suffix (CAN# Code) 'HR' or 'HT' must be used to ensure correct operation at this extended temperature range. Adesto will not modify and republish the current datasheet to reflect the CAN# 'HR' or 'HT' ordering code or the above caveats. The standard [AT25SF041 datasheet](http://www.adestotech.com) is available at <http://www.adestotech.com>.

1. Electrical Specifications

1.1 DC and AC Operating Range

		AT25SF041-xxxHR
Operating Temperature		-40°C to +125°C
Endurance (Maximum)		10,000 Cycles

1.2 DC Characteristics

Symbol	Parameter	Condition	2.5V to 3.6V			Units
			Min	Typ	Max	
I_{DDP}	Deep Power-Down Current	$\overline{CS}, \overline{HOLD}, \overline{WP} = V_{IH}$			10 ⁽¹⁾	μA
I_{SB}	Standby Current	$\overline{CS}, \overline{HOLD}, \overline{WP} = V_{IH}$			35 ⁽²⁾	μA

1. Industrial temperature limit is 5μA.
2. Industrial temperature limit is 25μA.

1.3 Program and Erase Characteristics

Symbol	Parameter	2.5V to 3.6V			
		Min	Typ	Max	Units
$t_{PP}^{(1)}$	Page Program Time (256 Bytes)		0.7	3.5	ms
$t_{CHPE}^{(1)(2)}$	Chip Erase Time		4	12	sec

1. Maximum values indicate worst-case performance after 100,000 erase/program cycles.
2. Not 100% tested (value guaranteed by design and characterization).

2. Ordering Code

2.1 Ordering Code Detail

Ordering Code ⁽¹⁾	Package	Operating Voltage	Max. Freq. (MHz)	Operation Range
AT25SF041-SHDHR-T	8S2	2.5V to 3.6V	85MHz	Extended (-40°C to +125°C)
AT25SF041-SHDHR-B				
AT25SF041-SSHDHR-T	8S1			
AT25SF041-SSHDHR-B				
AT25SF041-DWFHT ⁽²⁾	DWF			

1. The shipping carrier option code is not marked on the devices.
2. Contact Adesto for mechanical drawing or die sales information.

Package Type	
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline Package (JEDEC SOIC)
8S2	8-lead, 0.208" Wide, Plastic Gull Wing Small Outline Package (EIAJ SOIC)
DWF	Die in Wafer Form

3. Revision History

Revision Level – Release Date	History
A – August 2014	Initial release.
B – October 2015	Corrected package type in Ordering Code Detail table.
C – August 2016	Added DWF part ordering code.
D – August 2017	Updated corporate address information.



Corporate Office

California | USA

Adesto Headquarters

3600 Peterson Way

Santa Clara, CA 95054

Phone: (+1) 408.400.0578

Email: contact@adestotech.com

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